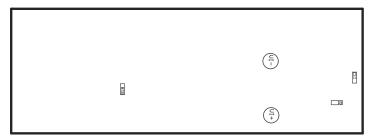


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #: PMP9402	REV: 1	SVN REV	: Not In VersionControl
IGNORE ->				
PLOT NAME = Top Assembly Drawing	GENERATED : 4/22/2	2015 5:48:29	PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP9402	REV: 1	SVN REV	: Not In VersionControl		
	IGNORE ->					
PLOT NAME = Bottom Assembly Drawing	GENERATED : 4/22/2	2015 5:48:30	PM	TEXAS INSTRUMENTS		

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